PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	577	STMicroelectronics International N.V
1.2 PCN No.		AMS/18/10777
1.3 Title of PCN		Qualification of ST Shenzhen as Assembly and Test & Finishing site for selected General Purpose Analog and Industrial & Power Conversion products in SO16 package
1.4 Product Category		Selected attached file
1.5 Issue date		2018-04-06

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	MARSHALL DAVE	
2.1.2 Phone		
2.1.3 Email	dave.marshall@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Matteo LO PRESTI	
2.1.2 Marketing Manager	Lorenzo NASO,Domenico ARRIGO	
2.1.3 Quality Manager	Paolo MORETTI	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	ST Shenzhen (China)	

4. Description of change			
	Old	New	
4.1 Description	Assembly and Test & Finishing site (except TSM104): - ST Bouskoura (Morocco)	Assembly and Test & Finishing site (except TSM104): - ST Bouskoura (Morocco) - ST Shenzhen (China)	
	For TSM104WAID and TSM104WAIDT only : Assembly and Test & Finishing site : - Subcontractor Amkor (Philippines)	For TSM104WAID and TSM104WAIDT only : Assembly : - Subcontractor Amkor (Philippines) Test & Finishing : - ST Shenzhen (China)	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact		

5. Reason / motivation for change		
	This additional plant will allow us to increase efficiency and production capacity. Customers demand will be better supported.	
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change	
6.1 Description	New finished good codes

7. Timing / schedule	
7.1 Date of qualification results	2018-03-12
7.2 Intended start of delivery	2018-06-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description 10777 10777Qual Report_SO16-fpdf			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2018-04-06

	9. Attachments (additional documentations)
10777 Public product.pdf 10777 10777Qual Report SO16-f .pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	ST232BDR	
1564303	ST232CDR	
	ST3232CDR	

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